



20V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	R _{DS(on)}	I _D max T _A = +25℃
	320mΩ @ V _{GS} = 4.5V	1.0A
20V	500mΩ @ V _{GS} = 2.5V	0.65A
	1000mΩ @ V _{GS} = 1.8V	0.4A

Description and Applications

This MOSFET is designed to minimize the on-state resistance $(R_{\text{DS(on)}})$ and yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

Load switch

Features and Benefits

- Footprint of just 0.6mm² thirteen times smaller than SOT23
- 0.4mm profile ideal for low profile applications
- Low Gate Threshold Voltage
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- ESD Protected Gate 2KV

Mechanical Data

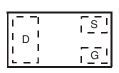
- Case: X2-DFN1006-3
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 @4)
- Weight: 0.001 grams (Approximate)



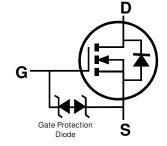




Bottom View



Top View Internal Schematic



Equivalent Circuit

Ordering Information (Note 4)

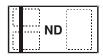
Part Number	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
DMN2320UFB4-7B	ND	7	8	10,000

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

DMN2320UFB4-7B



Top View Bar Denotes Gate and Source Side

ND = Product Type Marking Code



Maximum Ratings (@T_A = +25 °C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			V_{DSS}	20	V
Gate-Source Voltage			V _{GSS}	±8	V
Continuous Drain Current (Note 6) V _{GS} = 4.5V	Steady State	T _A = +25 °C T _A = +100 °C	I _D	1.0 0.7	А
Pulsed Drain Current (10µs pulse, duty cycle = 1%)			I _{DM}	6	Α

Thermal Characteristics (@TA = +25 °C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	P _D	0.52	W
Total Power Dissipation (Note 6)	P _D	1.07	W
Thermal Resistance, Junction to Ambient (Note 5)	$R_{\theta JA}$	240	°C/W
Thermal Resistance, Junction to Ambient (Note 6)	$R_{\theta JA}$	117	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	$^{\circ}$

Electrical Characteristics (@T_A = +25 °C, unless otherwise specified.)

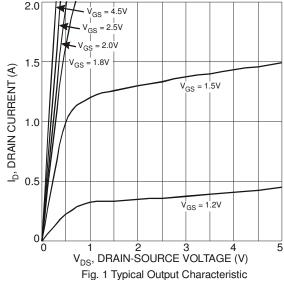
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	20	-	-	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current T _J = +25 °C	I_{DSS}	-	•	1	μΑ	$V_{DS} = 20V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	-	-	10	μΑ	$V_{GS} = \pm 8V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	$V_{GS(th)}$	0.50	-	0.95	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
		-	-	320	mΩ	$V_{GS} = 4.5V, I_D = 500mA$	
Static Drain-Source On-Resistance	R _{DS (ON)}	-	ı	500		$V_{GS} = 2.5V, I_D = 400mA$	
		-	-	1,000		$V_{GS} = 1.8V, I_D = 100mA$	
Diode Forward Voltage	V _{SD}	-	0.7	1.2	V	$V_{GS} = 0V, I_{S} = 300mA$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	-	71	-	рF	10)/)/	
Output Capacitance	Coss	-	12	-	рF	$V_{DS} = 10V, V_{GS} = 0V,$ - f = 1.0MHz	
Reverse Transfer Capacitance	C _{rss}	-	9.4	-	рF	T = T.OWITE	
Gate Resistance	R_g	-	69	-	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge	Qg	-	0.89	-	nC	V 45V V 40V	
Gate-Source Charge	Qgs	-	0.14	-	nC	$V_{GS} = 4.5V, V_{DS} = 10V,$	
Gate-Drain Charge	Q_{gd}	-	0.16	-	nC	$I_D = 1A$	
Turn-On Delay Time	t _{D(on)}	-	4.9	-	ns		
Turn-On Rise Time	t _r	-	6.9	-	ns	$V_{DS} = 10V, I_{D} = 1A$	
Turn-Off Delay Time	t _{D(off)}	-	21.7	-	ns	$V_{GS} = 4.5V, R_{G} = 6\Omega$	
Turn-Off Fall Time	t _f	-	10.6	-	ns		

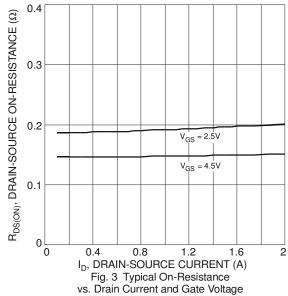
Notes:

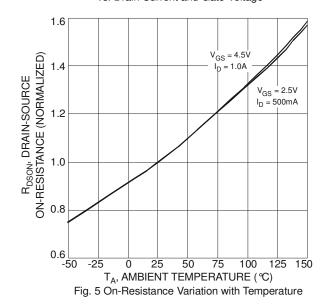
- Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PC board, 2oz copper, with 25mm X 25mm square copper plate.
- 7. Short duration pulse test used to minimize self-heating effect.
 8. Guaranteed by design. Not subject to product testing.

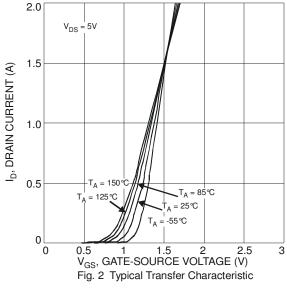


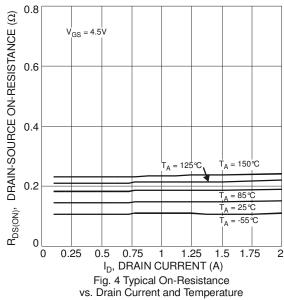


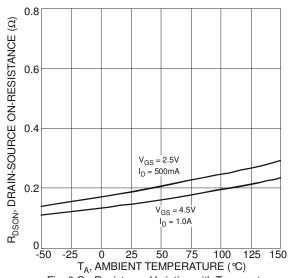






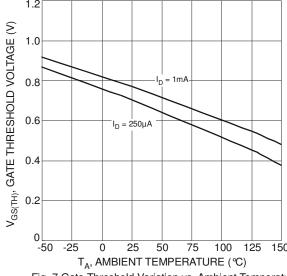


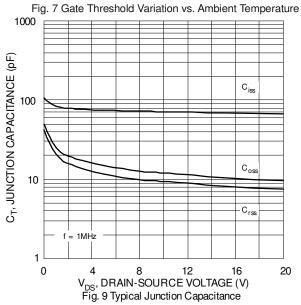


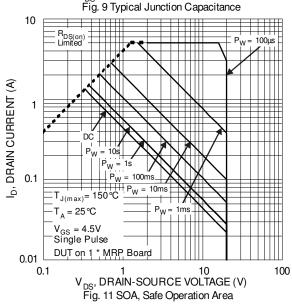


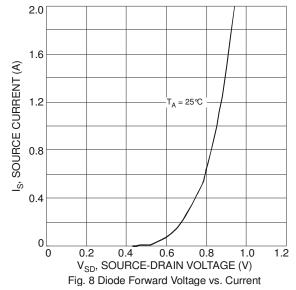
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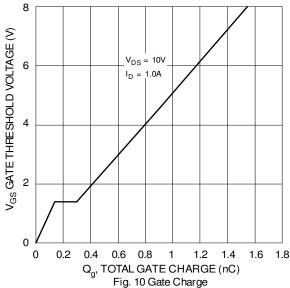




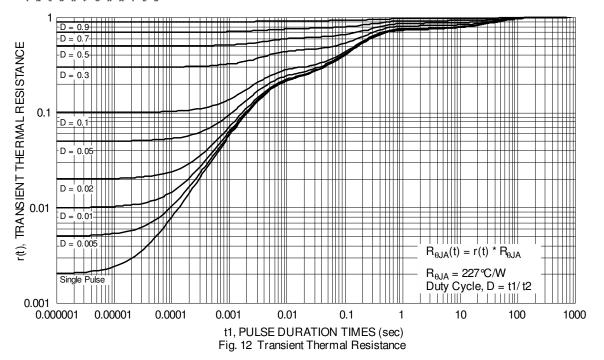








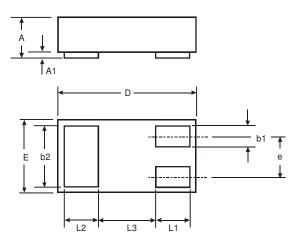






Package Outline Dimensions

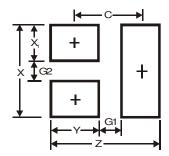
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



	X2-DFN1006-3					
Dim	Min	Max	Тур			
Α	_	0.40	_			
A1	0	0.05	0.03			
b1	0.10	0.20	0.15			
b2	0.45	0.55	0.50			
D	0.95	1.05	1.00			
Е	0.55	0.65	0.60			
е	_	_	0.35			
L1	0.20	0.30	0.25			
L2	0.20	0.30	0.25			
L3			0.40			
All	All Dimensions in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Z	1.1
G1	0.3
G2	0.2
Х	0.7
X1	0.25
Υ	0.4
С	0.7



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